Attorney's Docket No.: 042390P10637

COPY OF PAPERS ORIGINALLY FILED Patent LAWING

IN THE UNITED STATES PATENTAND TRADEMARK OFFICE

In Re Application of:

Thomas N. Marieb et al.

U.S. Serial No:

09/739,929

Filed:

December 18, 2000

For: COPPER ALLOYS FOR INTERCONNECTIONS HAVING IMPROVED ELECTROMIGRATION CHARACTERISTICS AND METHODS OF MAKING SAME

Assistant Commissioner for Patents and Trademarks
Washington, D.C. 20231

Examiner: Hoang, Quoc D.

Art Unit: 2818

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on tebruary 28, 200°

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Date /

FORMAL DRAWINGS SUBMISSION

Enclosed herewith for submission in the United States Patent and Trademark

Office are six (6) sheets of formal drawings for the patent application referenced above.

If there are any further charges please charge them to Deposit Account No. 02-2666. A duplicate of this sheet is enclosed for that purpose.

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

Dated: $\sqrt{\Lambda}$

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